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(71) Applicant (*for all designated States except US*): **CORNING INCORPORATED** [US/US]; 1 Riverfront Plaza, Corning, WY 14831 (US).

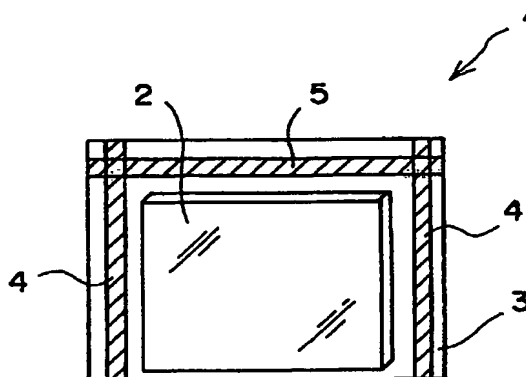
(72) Inventors; and

(75) Inventors/Applicants (*for US only*): **ABE, Makoto** [JP/JP]; 2-12-13, Shimomataminami, Kakegawa City, Shizuoka (JP). **YAMADA, Tetsuzou** [JP/JP]; 360 Takabatake, Hamakita City, Shizuoka (JP).

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(74) Agent: **KLEE, Maurice, M.**; 1951 Burr Street, Fairfield, CT 06824 (US).

(54) Title: GLASS SUBSTRATE PACKAGE



(57) Abstract: A glass substrate package (1) in which a glass substrate (2) is packed and sealed is prepared by folding a film such as a PET film (3) which does not dirty surfaces of the glass substrate (2), inserting the glass substrate (2) into the folded portion of the PET film (3), and heat sealing three sides of the folded portion of the PET film while squeezing the air out of the folded portion so that heat-sealed portions (4) and (5) are formed. The package achieves high efficiency in transportation and storage of glass substrates (specifically, glass substrates to be used for LCDs etc.), and concurrently eliminates the need for a chemical washing process which is carried out after unpacking and before processing of each glass substrate and which uses special detergents.

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